INTEGRATED CIRCUITS

DATA SHEET

74ALVT162245

2.5V/3.3V ALVT 16-bit transceiver with 30Ω termination resistors (3-State)

Product specification Supersedes data of 1996 Mar 05 IC23 Data Handbook





2.5V/3.3V 16-bit transceiver with 30 Ω termination resistors (3-State)

74ALVT162245

FEATURES

- 16-bit bidirectional bus interface
- 3-State buffers
- 5V I/O compatibile
- Output capability: +12mA/-12mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- \bullet Outputs include series resistance of 30Ω making external termination resistors unnecessary
- Power-up 3-State
- No bus current loading when output is tied to 5V bus
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

DESCRIPTION

The 74ALVT162245 is a high-performance BiCMOS product designed for V_{CC} operation at 2.5V or 3.3V with I/O compatibility up to 5V.

This device is a 16-bit transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features an Output Enable (nOE) input for easy cascading and a Direction (DIR) input for direction control.

The 74ALVT162245 is designed with 30Ω series resistance in both the High and Low states of the output. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus transceivers/transmitters.

QUICK REFERENCE DATA

SYMBOL PARAMETER		CONDITIONS	TYPI	UNIT		
STWIBOL	PARAMETER	T _{amb} = 25°C	2.5V	3.3V	01411	
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	C _L = 50pF	2.9 2.4	2.3 2.0	ns	
C _{IN}	Input capacitance DIR, OE	$V_I = 0V \text{ or } V_{CC}$	3	3	pF	
C _{I/O}	I/O pin capacitance	$V_{I/O} = 0V \text{ or } V_{CC}$	9	9	pF	
I _{CCZ}	Total supply current	Outputs disabled	40	70	μΑ	

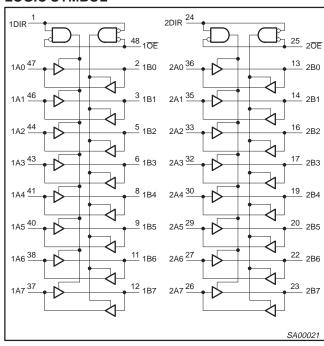
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	-40°C to +85°C	74ALVT162245 DL	AV162245 DL	SOT370-1
48-Pin Plastic TSSOP Type II	-40°C to +85°C	74ALVT162245 DGG	AV162245 DGG	SOT362-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 24	nDIR	Direction control input
47, 46, 44, 43, 41, 40, 38, 37, 36, 35, 33, 32, 30, 29, 27, 26	nA0 – nA7	Data inputs/outputs (A side)
2, 3, 5, 6, 8, 9, 11, 12, 13, 14, 16, 17, 19, 20, 22, 23	nB0 – nB7	Data inputs/outputs (B side)
25, 48	nŌĒ	Output enable input (active-Low)
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V _{CC}	Positive supply voltage

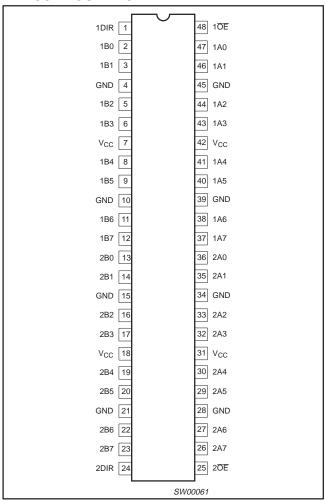
LOGIC SYMBOL



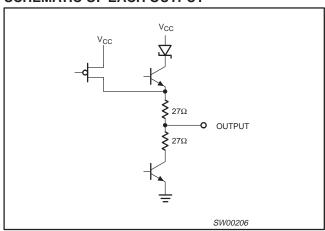
2.5V/3.3V 16-bit transceiver with 30Ω termination resistors (3-State)

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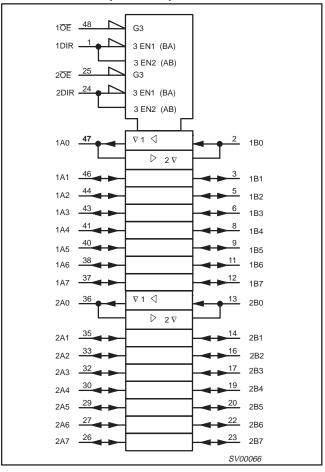
PIN CONFIGURATION



SCHEMATIC OF EACH OUTPUT



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

INP	UTS	INPUTS/OUTPUTS				
nOE	nDIR	nAx	nBx			
L	L	nAx = nBx	Inputs			
L	Н	Inputs	nBx = nAx			
Н	Х	Z	Z			

H = High voltage level

= Low voltage level

X = Don't care Z = High Impedance "off" state

2.5V/3.3V 16-bit transceiver with 30Ω termination resistors (3-State)

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ABSOLUTE MAXIMUM RATINGS^{1,2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
VI	DC input voltage ³		-0.5 to +7.0	V
lok	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V
	DC output ourrent	Output in Low state	128	A
lout	DC output current	Output in High state	-64	mA
T _{stg}	Storage temperature range		-65 to +150	°C

NOTES:

RECOMMENDED OPERATING CONDITIONS

SVMBOL	SYMBOL PARAMETER		2.5V RANGE LIMITS		3.3V RANGE LIMITS	
STWIBOL	TANAMETER	MIN	MAX	MIN	MAX	UNIT
V _{CC}	DC supply voltage	2.3	2.7	3.0	3.6	V
VI	Input voltage	0	5.5	0	5.5	V
V _{IH}	High-level input voltage	1.7		2.0		V
V _{IL}	Input voltage		0.7		0.8	V
I _{OH}	High-level output current		-8		-12	mA
I _{OL}	Low-level output current		12		12	mA
Δt/Δν	Input transition rise or fall rate; Outputs enabled		10		10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	-40	+85	°C

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

^{3.} The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

2.5V/3.3V 16-bit transceiver with 30Ω termination resistors (3-State)

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DC ELECTRICAL CHARACTERISTICS (3.3V \pm 0.3V RANGE)

					LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	TEST CONDITIONS		Temp = -40°C to +85°C		UNIT
				MIN	TYP ¹	MAX	
V_{IK}	Input clamp voltage	$V_{CC} = 3.0V; I_{IK} = -18mA$			-0.85	-1.2	V
V _{OH}	High-level output voltage	$V_{CC} = 3.0V; I_{OH} = -12mA$		2.0	2.3		V
V _{OL}	Low-level output voltage	V _{CC} = 3.0V; I _{OL} = 12mA			0.6	0.8	V
		$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND	Control pins		0.1	±1	
I.	Input leakage current	V _{CC} = 0 or 3.6V; V _I = 5.5V			01.	10	
†I	Input leakage current	$V_{CC} = 3.6V; V_{I} = V_{CC}$	Data pina4		0.5	1	μΑ
		V _{CC} = 3.6V; V _I = 0V	Data pins ⁴		0.1	-5	
I _{OFF}	Off current	$V_{CC} = 0V$; V_1 or $V_0 = 0$ to 4.5V			0.1	±100	μΑ
	Bus Hold current	$V_{CC} = 3V; V_I = 0.8V$		75	130		μΑ
I _{HOLD}		V _{CC} = 3V; V _I = 2.0V		-75	-140		
	Data inputs ⁶	$V_{CC} = 0V \text{ to } 3.6V; V_{CC} = 3.6V$		±500			1
I _{EX}	Current into an output in the High state when V _O > V _{CC}	V _O = 5.5V; V _{CC} = 3.0V			50	125	μΑ
I _{PU/PD}	Power up/down 3-State output current ³	$V_{CC} \le 1.2V$; $V_O = 0.5V$ to V_{CC} ; $V_I = GND$ or V_{CC} OE/OE = Don't care			40	±100	μΑ
I _{CCH}		$V_{CC} = 3.6V$; Outputs High, $V_{I} = GND$ or V_{CC} , $I_{O} = 0$			0.07	0.1	
I _{CCL}	Quiescent supply current	$V_{CC} = 3.6V$; Outputs Low, $V_I = GND$ or V_{CC} , $I_O = 0$			3.5	5	mA
I _{CCZ}	1	$V_{CC} = 3.6V$; Outputs Disabled; $V_I = GND$ or V_{CC} , $I_O = 0^5$			0.07	0.1	
Δl _{CC}	Additional supply current per input pin ²	V_{CC} = 3V to 3.6V; One input at V_{CC} -0.6' Other inputs at V_{CC} or GND	V,		0.04	0.4	mA

NOTES:

- All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
 This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND
- This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From V_{CC} = 1.2V to V_{CC} = 3.3V ± 0.3V a transition time of 100μsec is permitted. This parameter is valid for T_{amb} = 25°C only.
 Unused pins at V_{CC} or GND.

- 5. I_{CCZ} is measured with outputs pulled up to V_{CC} or pulled down to ground.
 6. This is the bus hold overdrive current required to force the input to the opposite logic state.

AC CHARACTERISTICS (3.3V \pm 0.3V RANGE)

GND = 0V; $t_R = t_F = 2.5 \text{ns}$; $C_L = 50 \text{pF}$; $R_L = 500 \Omega$; $T_{amb} = -40 ^{\circ} \text{C}$ to $+85 ^{\circ} \text{C}$.

			LIMITS			
SYMBOL	PARAMETER	PARAMETER WAVEFORM $V_{CC} = 3.3V \pm 0.3V$		UNIT		
			MIN	TYP ¹	MAX	
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	1	0.5 0.5	2.3 2.0	3.6 3.1	ns
^t PZH t _{PZL}	Output enable time to High and Low level	2	1.0 1.0	3.0 2.6	5.0 3.9	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low Level	2	1.0 1.0	3.6 3.0	5.2 4.6	ns

1. All typical values are at $V_{CC} = 3.3V$ and $T_{amb} = 25^{\circ}C$.

2.5V/3.3V 16-bit transceiver with 30Ω termination resistors (3-State)

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DC ELECTRICAL CHARACTERISTICS (2.5V \pm 0.2V RANGE)

					LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS		TEST CONDITIONS Temp = -40°C to +85°		+85°C	UNIT
				MIN	TYP ¹	MAX	1
V _{IK}	Input clamp voltage	$V_{CC} = 2.3V; I_{IK} = -18mA$			-0.85	-1.2	V
V _{OH}	High-level output voltage	$V_{CC} = 2.3V; I_{OH} = -8mA$		1.7			V
V _{OL}	Low-level output voltage	$V_{CC} = 2.3V; I_{OL} = 12mA$			0.6	0.7	l v
		$V_{CC} = 2.7V$; $V_I = V_{CC}$ or GND	Control pins		0.1	±1	
l .	Input leakage current	$V_{CC} = 0 \text{ or } 2.7V; V_I = 5.5V$			0.1	10	μΑ
tı tı	Input leakage current	$V_{CC} = 2.7V; V_{I} = V_{CC}$	Data pins ⁴		0.1	1	
		$V_{CC} = 2.7V; V_I = 0$	Data piris		0.1	-5	
I _{OFF}	Off current	$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5V$			0.1	±100	μА
1	Bus Hold current	$V_{CC} = 2.3V; V_I = 0.7V$			90		μА
HOLD	Data inputs ⁶	V _{CC} = 2.3V; V _I = 1.7V			-75		μΑ
I _{EX}	Current into an output in the High state when V _O > V _{CC}	V _O = 5.5V; V _{CC} = 2.3V			20	125	μА
I _{PU/PD}	Power up/down 3-State output current ³	$V_{CC} \le 1.2V$; $V_O = 0.5V$ to V_{CC} ; $V_I = GND$ or V_{CC} OE/OE = Don't care			40	100	μА
I _{CCH}		$V_{CC} = 2.7V$; Outputs High, $V_I = GND$ or V_{CC} , $I_O = 0$			0.04	0.1	
I _{CCL}	Quiescent supply current	$V_{CC} = 2.7V$; Outputs Low, $V_I = GND$ or V_{CC} , $I_O = 0$			2.5	4.5	mA
I _{CCZ}	1	$V_{CC} = 2.7V$; Outputs Disabled; $V_I = GND$ or V_{CC} , $I_O = 0^5$			0.04	0.1	
Δl _{CC}	Additional supply current per input pin ²	V_{CC} = 2.3V to 2.7V; One input at V_{CC} -0. Other inputs at V_{CC} or GND	.6V,		0.05	0.4	mA

NOTES:

- All typical values are at V_{CC} = 2.5V and T_{amb} = 25°C.
 This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND
 This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From V_{CC} = 1.2V to V_{CC} = 2.5V ± 0.2V a transition time of 100 μ sec is permitted. This parameter is valid for $T_{amb} = 25$ °C only.
- 4. Unused pins at V_{CC} or GND.
- 5. I_{CCZ} is measured with outputs pulled up to V_{CC} or pulled down to ground.
- 6. Not guaranteed.

AC CHARACTERISTICS (2.5V \pm 0.2V RANGE)

GND = 0V; $t_R = t_F = 2.5 \text{ns}$; $C_L = 50 \text{pF}$; $R_L = 500 \Omega$; $T_{amb} = -40 ^{\circ} \text{C}$ to $+85 ^{\circ} \text{C}$.

				LIMITS		
SYMBOL	PARAMETER	WAVEFORM	V _C	V_{CC} = 2.5V \pm 0.2V		UNIT
			MIN	TYP ¹	MAX	
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	1	1.5 1.5	2.9 2.4	5.3 4.7	ns
t _{PZH}	Output enable time to High and Low level	2	1.5 1.5	4.3 3.1	6.3 4.6	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low Level	2	1.5 1.5	4.2 3.3	6.2 5.1	ns

NOTE:

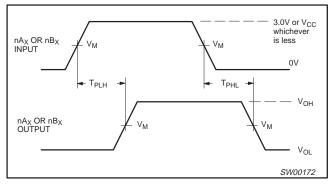
1. All typical values are at V_{CC} = 2.5V and T_{amb} = 25°C.

2.5V/3.3V 16-bit transceiver with 30Ω termination resistors (3-State)

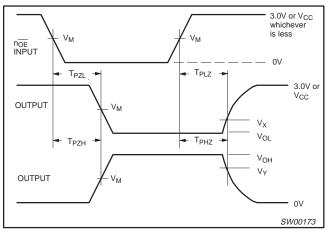
74ALVT162245

AC WAVEFORMS

- 1. $V_M = 1.5V$ at $V_{CC} \ge 3.0V$, $V_M = V_{CC}/2$ at $V_{CC} \le 2.7V$ 2. $V_X = V_{OL} + 0.3V$ at $V_{CC} \ge 3.0V$, $V_X = V_{OL} + 0.1 \cdot V_{CC}$ at $V_{CC} \le 2.7V$ 3. $V_Y = V_{OH} 0.3V$ at $V_{CC} \ge 3.0V$, $V_Y = V_{OH} 0.1 \cdot V_{CC}$ at $V_{CC} \le 2.7V$

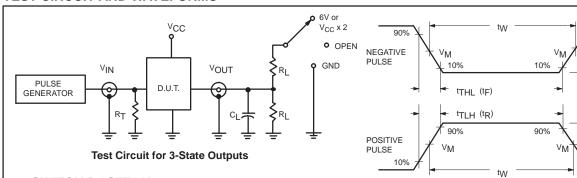


Waveform 1. Input to Output Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



SWITCH POSITION

TEST	SWITCH
t _{PHZ} /t _{PZH}	GND
t _{PLZ} /t _{PZL}	6V or V _{CC} x 2
t _{PLH} /t _{PHL}	open

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

 C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

 R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

=4.14U.V	INPUT PULSE REQUIREMENTS							
FAMILY	Amplitude	Rep. Rate	t _W	t _R	t _F			
74ALVT16	3.0V or V _{CC} whichever is less	≤10MHz	500ns	≤2.5ns	≤2.5ns			

 $V_M = 1.5V$ or $V_{CC}/2$, whichever is less **Input Pulse Definition**

SW00162

AMP (V)

tTLH (tR)

 t_{THL} (t_F) AMP (V)

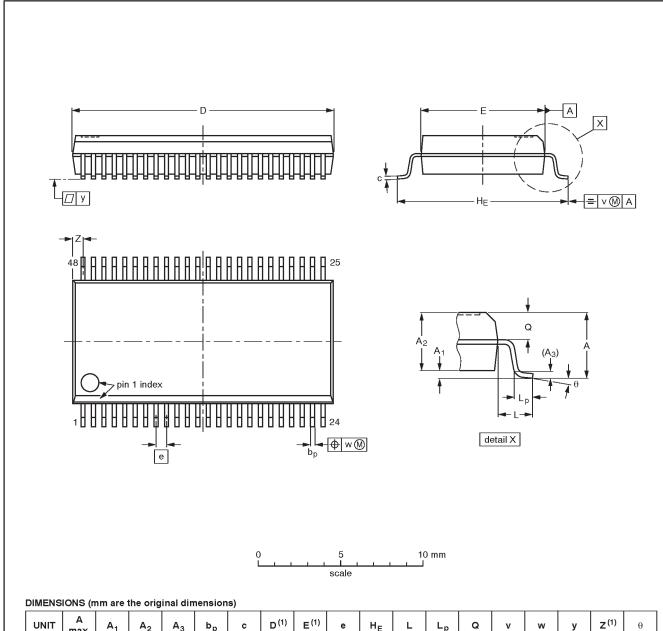
0V

2.5V/3.3V ALVT 16-bit transceiver with 30Ω termination resistors (3-State)

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SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

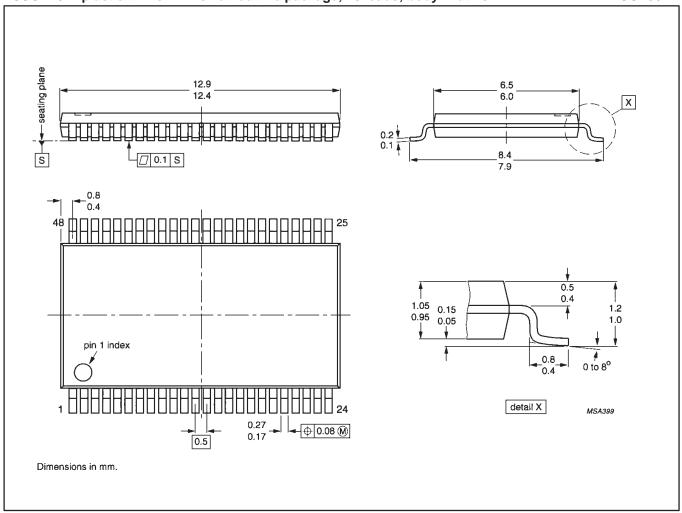
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OL	JTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE	
sc	DT370-1		MO-118AA			93-11-02 95-02-04

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



2.5V/3.3V ALVT 16-bit transceiver with 30Ω termination resistors (3-State)

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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